PCN Number: 20			201	20170926010			CN Date:	October 09, 2017		
		·	TPS65185, TPS651851				0000001 03, 2017			
			N Manager				Dept:		Quality Services	
		Type:	<u> </u>	l	<u> </u>				PCI	Quality Services
		embly Site				Design			Wafe	er Bump Site
\blacksquare	Assembly Process				X	Data Sheet			_	er Bump Material
Assembly Materials						Part numbe		Wafer Bump Process		
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Cha	nges t	rom Revision F (J	June 2	017) to Re	evisi	on G				Page
 Added capacitor connection to the pin description for INT_LDO, VB, VCOM, VCOM_PWR, VDDH_D, VEE_D, VIN, VIN_P, VN, VNEG, VNEG_IN, VPOS, VPOS_IN, VREF in the <i>Pin Functions</i> table										
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http	o://w	ww.ti.com/prod	duct/	TPS651	<u>85</u>					
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		pated impact. tual device.	This	is a spe	cific	ation change	e announcer	nent o	nly. T	here are no changes
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		851RSLR		TPS651	851	RSLT	TPS65185	RGZR		TPS65185RGZT

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
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